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ON Semiconductor[®]

FDC642P Single P-Channel 2.5V Specified PowerTrench[®] MOSFET -20 V, -4.0 A, 65 m Ω

Features

- Max $r_{DS(on)}$ = 65 m Ω at V_{GS} = -4.5 V, I_D = -4.0 A
- Max $r_{DS(on)}$ = 100 m Ω at V_{GS} = -2.5 V, I_D = -3.2 A
- Fast switching speed
- Low gate charge (11nC typical)
- High performance trench technology for extremely low r_{DS(on)}
- SuperSOTTM-6 package: small footprint (72% smaller than standard SO-8); low profile (1 mm thick)
- Termination is Lead-free and RoHS Compliant



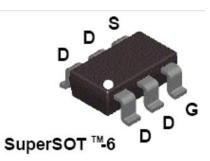
General Description

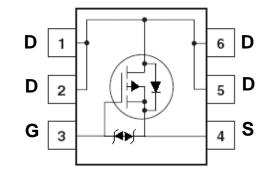
This P-Channel 2.5V specified MOSFET is produced using ON Semicondcutor's advanced PowerTrench[®] process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

These devices have been designed to offer exceptional power dissipation in a very small footprint for applications where the larger packages are impractical.

Applications

- Load switch
- Battery protection
- Power management





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parame	Ratings	Units			
V _{DS}	Drain to Source Voltage			-20	V	
V _{GS}	Gate to Source Voltage			±8	V	
1	-Continuous	T _A = 25°C	(Note 1a)	-4.0	٨	
D	-Pulsed			-20	Α	
D	Power Dissipation		(Note 1a)	1.6	w	
P _D	Power Dissipation (Note 1b)			0.8	V	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to + 150	°C	

Thermal Characteristics

	$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	78
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Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.642	FDC642P	SSOT-6 [™]	7 "	8 mm	3000 units

°C/W

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = -250 \ \mu A, V_{GS} = 0 \ V$	-20			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25°C		-13		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 V, V_{GS} = 0 V$			-1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8$ V, $V_{DS} = 0$ V			±10	μΑ	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250 μA	-0.4	-0.6	-1.5	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25°C		2.5		mV/°C	
	Static Drain to Source On Resistance	V _{GS} = -4.5 V, I _D = -4.0 A		45	65		
r _{DS(on)}		$V_{GS} = -2.5 \text{ V}, I_D = -3.2 \text{ A}$		55	100	mΩ	
'DS(on)		$V_{GS} = -4.5 V, I_D = -4.0 A, T_J = 125^{\circ}C$		62	90	- 11152	
9 _{FS}	Forward Transconductance	$V_{DS} = -5 V, I_{D} = -4.0 A$		15		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance			700	925	pF	
C _{oss}	Output Capacitance	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz		110	150	pF	
C _{rss}	Reverse Transfer Capacitance			95	145	pF	
	Characteristics						
t _{d(on)}	Turn-On Delay Time			6	12	ns	
t _r	Rise Time	V_{DD} = -10 V, I _D = -1 A, V _{GS} = -4.5 V, R _{GEN} = 6 Ω		7	14	ns	
t _{d(off)}	Turn-Off Delay Time			120	190	ns	
t _f	Fall Time			52	83	ns	
Q _g	Total Gate Charge			11	16	nC	
Q _{gs}	Gate to Source Charge	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -4 \text{ A}$ $V_{GS} =4.5 \text{ V}$		1.1		nC	
Q _{ad}	Gate to Drain "Miller" Charge	VGS+.0 V		3.0		nC	

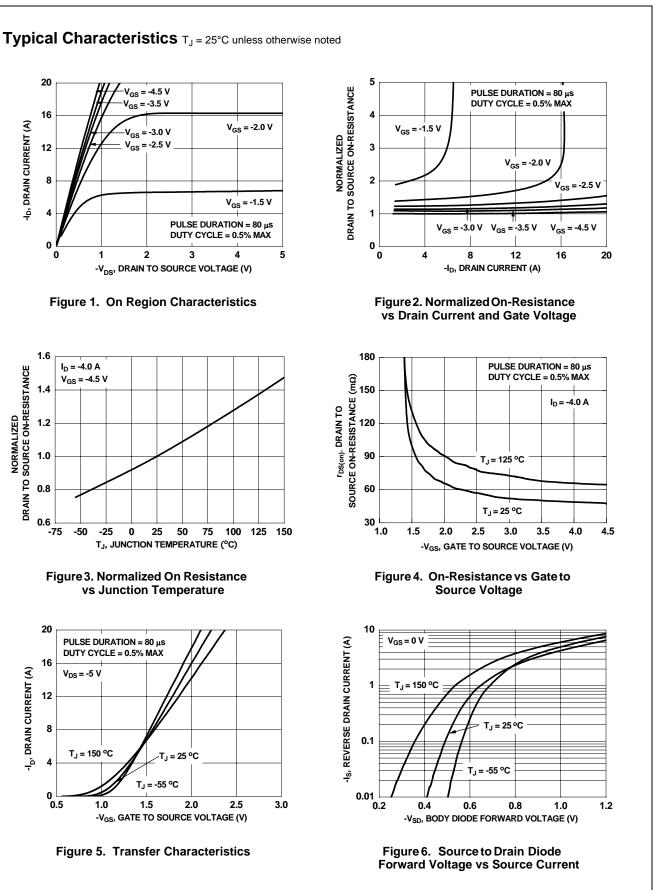
I _S	Maximum Continuous Drain-Source Diode F	Forward Current			-1.3	А
V _{SD}	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -1.3 A$	(Note 2)	-0.7	-1.2	V

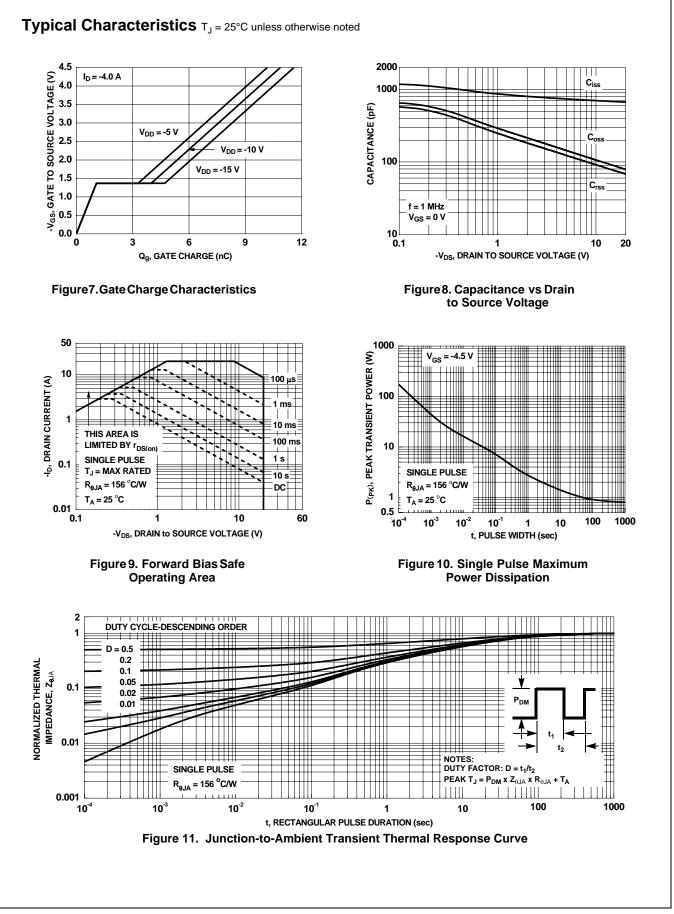
Notes:

1: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

a. 78 °C/W when mounted on a 1 in² pad of 2 oz copper. b. 156°C/W when mounted on a minimum pad of 2 oz copper.

2: Pulse Test: Pulse Width<300 us, Duty Cycle<2.0%.





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